

3.3V, 5V, 12V or 24V Input / 1W / 3kV Functional Isolated / Unregulated 5V Output

DESCRIPTION

The FISM 1769205x41 MagI³C power module series are unregulated, functionally isolated, fully integrated DC/DC converters.

The modules integrate the switching power stage, control circuitry, transformer and input/output capacitors.

The modules require no external components for operation thus reducing design effort and complexity to a minimum.

The FISM family ensures fast time to market and low development costs.

The 1769205x41 series of the FISM family achieves an efficiency of 84% to 90.5%.

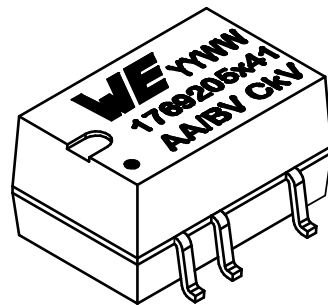
The series is available in an SMT-8 package (13.2 x 11.4 x 7.25)mm.

FEATURES

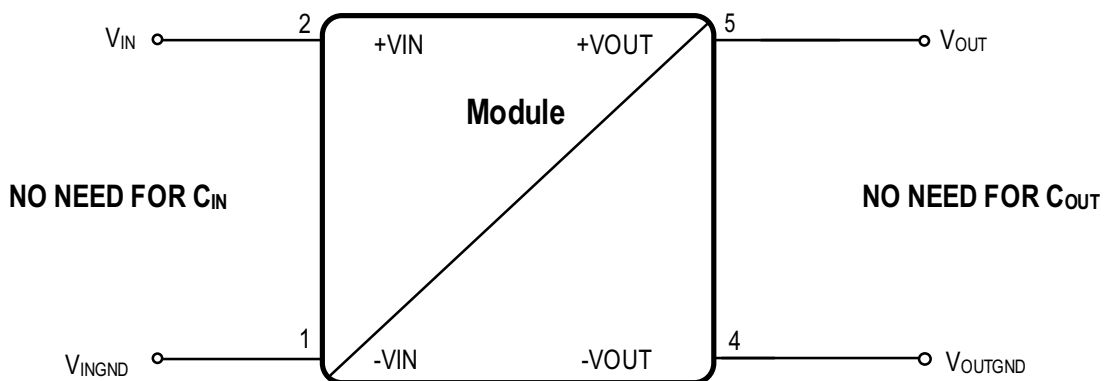
- 3kV DC functional isolation for 60s
- Nominal input voltage rails: 3.3V / 5V / 12V / 24V
- Output voltage: 5V unregulated
- Low output voltage ripple: Typ. 55mV at full load
- Output voltage accuracy: Typ. -2.5% at full load
- Output power: 1W (0.2A)
- Dynamic power boost up to 0.3A for 0.5s
- Continuous short-circuit protection
- Isolation capacitance of typ. 20pF
- Integrated C_{IN}, C_{OUT} and transformer
- Operating ambient temperature range: -40°C to 105°C
- RoHS & REACH compliant
- Complies with EN55032 (CISPR-32) class B conducted and radiated emissions standard
- UL62368-1 approved

TYPICAL APPLICATIONS

- Data acquisition
- Test and measurement systems
- Interface and microcontroller supplies
- Industrial control



TYPICAL CIRCUIT DIAGRAM



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1 PINOUT

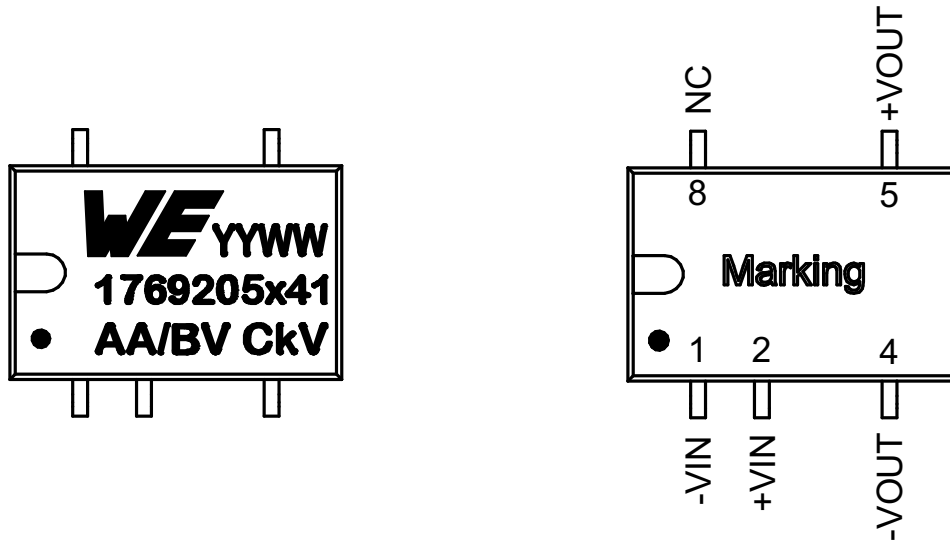


Figure 1: Pinout.

Table 1: Marking description.

| MARKING | DESCRIPTION |
|------------|--------------------------------------|
| WE | Würth Elektronik eiSos GmbH & Co. KG |
| YY | Year |
| WW | Calendar week |
| 1769205x41 | Order code |
| AA | Input voltage |
| B | Output voltage |
| C | Isolation voltage |

Table 2: Pin description.

| SYMBOL | NUMBER | TYPE | DESCRIPTION |
|--------|--------|-------|--------------------|
| -VIN | 1 | Power | Input ground pin |
| +VIN | 2 | Power | Input voltage pin |
| -VOUT | 4 | Power | Output ground pin |
| +VOUT | 5 | Power | Output voltage pin |
| NC | 8 | — | Not connected |

2 ORDERING INFORMATION

Table 3: Ordering information.

| ORDER CODE | SPECIFICATIONS | PACKAGE | PACKAGING UNIT |
|------------|-------------------|---------|-----------------------|
| 1769205041 | 3.3V / 5V version | SMT-8 | 13" Reel (500 pieces) |
| 1769205141 | 5V / 5V version | SMT-8 | 13" Reel (500 pieces) |
| 1769205241 | 12V / 5V version | SMT-8 | 13" Reel (500 pieces) |
| 1769205341 | 24V / 5V version | SMT-8 | 13" Reel (500 pieces) |

3 PINOUT COMPATIBLE FAMILY MEMBERS

Table 4: Pinout compatible family members.

| ORDER CODE | SPECIFICATIONS | PACKAGE | PACKAGING UNIT |
|------------|-------------------|---------|-----------------------|
| 1769405141 | 5V / 5V version | SMT-8 | 13" Reel (500 pieces) |
| 1769405241 | 12V / 5V version | SMT-8 | 13" Reel (500 pieces) |
| 1769405341 | 24V / 5V version | SMT-8 | 13" Reel (500 pieces) |
| 176920502 | 3.3V / 5V version | SMT-8 | 13" Reel (500 pieces) |
| 176920512 | 5V / 5V version | SMT-8 | 13" Reel (500 pieces) |
| 176920522 | 12V / 5V version | SMT-8 | 13" Reel (500 pieces) |
| 176881212 | 5V / 12V version | SMT-8 | 13" Reel (500 pieces) |
| 176861512 | 5V / 15V version | SMT-8 | 13" Reel (500 pieces) |

4 SALES INFORMATION

| SALES CONTACT |
|---|
| Würth Elektronik eiSos GmbH & Co. KG EMC and Inductive Solutions Max-Eyth-Str. 1 74638 Waldenburg Germany Tel. +49 (0) 7942 945 0 www.we-online.com/powermodules Technical support: powermodules@we-online.com |

5 ABSOLUTE MAXIMUM RATINGS

Caution:

Exceeding the listed absolute maximum ratings may affect the device negatively and may cause permanent damage.

Table 5: Absolute maximum ratings.

| SYMBOL | PARAMETER | | LIMIT | | UNIT |
|----------------------|---|---|--------------------|--------------------|------|
| | | | MIN ⁽¹⁾ | MAX ⁽¹⁾ | |
| VIN | Input pin voltage | 3.3V _{IN} / 5V _{OUT} version (1769205041) | -0.4 | 9 | V |
| | | 5V _{IN} / 5V _{OUT} version (1769205141) | -0.4 | 10 | V |
| | | 12V _{IN} / 5V _{OUT} version (1769205241) | -0.4 | 16 | V |
| | | 24V _{IN} / 5V _{OUT} version (1769205341) | -0.4 | 50 | V |
| VOUT | Output pin voltage | 3.3V _{IN} / 5V _{OUT} version (1769205041) | -0.7 | 16 | V |
| | | 5V _{IN} / 5V _{OUT} version (1769205141) | -0.7 | 16 | V |
| | | 12V _{IN} / 5V _{OUT} version (1769205241) | -0.7 | 25 | V |
| | | 24V _{IN} / 5V _{OUT} version (1769205341) | -0.7 | 16 | V |
| V _{ISO} | Isolation voltage input to output for 1s ⁽⁶⁾ | | — | 4 | kV |
| | Isolation voltage input to output, 100% tested for 60s ⁽⁷⁾ | | — | 3 | kV |
| T _{storage} | Assembled, non-operating storage temperature | | -55 | 125 | °C |
| V _{ESD} | ESD Voltage (HBM), according to EN61000-4-2 ⁽⁴⁾ | | -4 | 4 | kV |

6 OPERATING CONDITIONS

Operating conditions are conditions under which the device is intended to be functional. All values are referenced to GND.

MIN and MAX limits are valid for the recommended ambient temperature range of -40°C to 105°C.

Table 6: Operating conditions.

| SYMBOL | PARAMETER | | MIN ⁽¹⁾ | TYP ⁽³⁾ | MAX ⁽¹⁾ | UNIT |
|----------------------|---|---|--------------------|--------------------|--------------------|------|
| V _{IN} | Input Voltage | 3.3V _{IN} / 5V _{OUT} version (1769205041) | 2.97 | 3.3 | 3.63 | V |
| | | 5V _{IN} / 5V _{OUT} version (1769205141) | 4.5 | 5 | 5.5 | V |
| | | 12V _{IN} / 5V _{OUT} version (1769205241) | 10.8 | 12 | 13.2 | V |
| | | 24V _{IN} / 5V _{OUT} version (1769205341) | 21.6 | 24 | 26.4 | V |
| V _{OUT} | Output Voltage | | — | 5 | — | V |
| I _{OUT} | Nominal output current ⁽⁵⁾ | | — | — | 0.2 | A |
| P _{OUT} | Nominal output power (without derating) | | — | — | 1 | W |
| C _{OUT_MAX} | Maximal output capacitance | | — | — | 2400 | μF |
| T _a | Ambient temperature range | | -40 | — | 105 ⁽²⁾ | °C |
| T _{JOP} | Junction temperature range | | -40 | — | 125 | °C |

7 THERMAL SPECIFICATIONS

Caution:

Exceeding the listed absolute maximum ratings may affect the device negatively and may cause permanent damage.

Table 7: Thermal specifications.

| SYMBOL | PARAMETER | TYP ⁽³⁾ | UNIT |
|-----------------------|-------------------------------------|--------------------|------|
| T _{Case_Max} | Maximum case temperature (top side) | 105 | °C |

8 ELECTRICAL SPECIFICATIONS

Caution:


MIN and MAX limits are valid for the recommended ambient temperature range of -40°C to 105°C. Typical values represent statistically the utmost probable values at the following conditions: $T_A = 25^\circ\text{C}$, unless otherwise noted.

Table 8: Electrical specifications.

| SYMBOL | PARAMETER | TEST CONDITIONS | MIN ⁽¹⁾ | TYP ⁽³⁾ | MAX ⁽¹⁾ | UNIT |
|--|--|---|--------------------|---------------------|--------------------|------------------|
| Output Current | | | | | | |
| I_{MOC} | Maximum overload current | | — | — | 0.3 ⁽⁸⁾ | A |
| Accuracy | | | | | | |
| V_{OUT} | Line regulation | per 1.0% change in input voltage ⁽⁹⁾ | — | — | 1.2 | % |
| | Load Regulation | V_{IN} nominal, $V_{OUT} = 5V$ $I_{OUT} = 0.02A$ to $0.2A$ | — | 10 | 15 | % |
| | Output voltage accuracy | V_{IN} nominal, $I_{OUT} = 0.2A$ | — | -2.5 | — | % |
| | Output voltage at no load | V_{IN} nominal | — | 5.5 | — | V |
| | Output voltage ripple & noise | V_{IN} nominal, $V_{OUT} = 5V$ 20MHz BWL (1769205041) | — | 75 | — | mV _{pp} |
| V_{IN} nominal, $V_{OUT} = 5V$ 20MHz BWL (remaining versions) | | — | 55 | — | mV _{pp} | |
| Switching Frequency | | | | | | |
| f_{SW} | Switching frequency, internal clock | V_{IN} nominal, $I_{OUT} = 0.2A$ (1769205041) | — | 220 | — | kHz |
| | Switching frequency, input current | V_{IN} nominal, $I_{OUT} = 0.2A$ (1769205041) | — | 440 ⁽¹⁰⁾ | — | kHz |
| | Switching frequency, output voltage ripple | V_{IN} nominal, $I_{OUT} = 0.2A$ (1769205041) | — | 440 ⁽¹⁰⁾ | — | kHz |
| | Switching frequency, internal clock | V_{IN} nominal, $I_{OUT} = 0.2A$ (remaining versions) | — | 300 | — | kHz |
| | Switching frequency, input current | V_{IN} nominal, $I_{OUT} = 0.2A$ (remaining versions) | — | 600 ⁽¹⁰⁾ | — | kHz |
| | Switching frequency, output voltage ripple | V_{IN} nominal, $I_{OUT} = 0.2A$ (remaining versions) | — | 600 ⁽¹⁰⁾ | — | kHz |
| Input Current | | | | | | |
| I_{IN} | No load input current (operating, switching) | $V_{IN} = 3.3V$, $I_{OUT} = 0A$ (1769205041) | — | 8 | — | mA |
| | | $V_{IN} = 5V$, $I_{OUT} = 0A$ (1769205141) | — | 5 | — | mA |
| | | $V_{IN} = 12V$, $I_{OUT} = 0A$ (1769205241) | — | 4 | — | mA |
| | | $V_{IN} = 24V$, $I_{OUT} = 0A$ (1769205341) | — | 4 | — | mA |
| Efficiency | | | | | | |
| η | Efficiency | $V_{IN} = 3.3V$, $I_{OUT} = 0.2A$ (1769205041) | — | 84 | — | % |
| | | $V_{IN} = 5V$, $I_{OUT} = 0.2A$ (1769205141) | — | 90.5 | — | % |
| | | $V_{IN} = 12V$, $I_{OUT} = 0.2A$ (1769205241) | — | 90 | — | % |
| | | $V_{IN} = 24V$, $I_{OUT} = 0.2A$ (1769205341) | — | 86 | — | % |
| Isolation Characteristics | | | | | | |
| C_{ISO} | Isolation capacitance | 100kHz/0.1V | — | 20 | — | pF |
| R_{ISO} | Isolation resistance | 500VDC | 1 | — | — | G Ω |


9 APPROVALS

Table 9: Approvals.

| SYMBOL | STANDARD | DESCRIPTION |
|---|----------------------------------|---|
|  | 62368-1, 2 nd Edition | Recognized for use as Audio/Video, Information and Communication Technology Equipment, U.S.A. (UL62368-1) and Canada (C22.2 No. 62368-1) E-File: E497615 Applicable for altitudes up to 2000m |

10 RoHS, REACH

Table 10: RoHS, REACH.

| | | |
|-----------------|---|---|
| RoHS directive |  | Directive 2011/65/EU of the European Parliament and the Council of June 8th, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment. |
| REACH directive | | Directive 1907/2006/EU of the European Parliament and the Council of June 1st, 2007 regarding the Registration, Evaluation, Authorization and Restriction of Chemicals (REACH). |

11 PACKAGE SPECIFICATIONS

Table 11: Package specifications.

| ITEM | PARAMETER | TYP ⁽³⁾ | UNIT |
|----------------|--|--------------------|------|
| Case | UL94V-0 (Refer to UL approval E150608) | — | — |
| φ (RH) | Maximum storage humidity (see HANDLING RECOMMENDATIONS for soldering requirements) | 95 | % |
| Weight | | 1.3 | g |
| Vibration | MIL-STD-202G: 5g for 1 minute, 120 cycles each of 3 orientation, test from 10Hz-55Hz | | |
| IP | Degree of protection according to IEC/EC 60529 | X0 | |
| Washing | Washing compatible with standard industrial water based washers. | | |

12 RELIABILITY

Table 12: Reliability.

| SYMBOL | PARAMETER | TEST CONDITIONS | TYP ⁽³⁾ | UNIT |
|----------------------|----------------------------|-----------------------|-------------------------|------|
| MTBF ⁽¹¹⁾ | Mean Time Between Failures | +25°C: Ground Benign | 28000 · 10 ³ | h |
| | | +100°C: Ground Benign | 5000 · 10 ³ | h |

13 NOTES

- (1)** Min and Max limits are 100% production tested at 25°C. Limits over the operating temperature range are guaranteed through correlation using Statistical Quality Control (SQC) methods.
- (2)** Measured without heatsink. Natural convection (0 - 20LFM / 0 - 0.1m/s) Test PCB 80mm x 80mm horizontal orientation 35µm copper on top and bottom.
- (3)** Typical numbers are valid at 25°C ambient temperature and represent statistically the utmost probability assuming the Gaussian distribution.
- (4)** The human body model is a 100pF capacitor discharged through a 1.5 kΩ resistor into each pin. Test method is per JESD-22-114.
- (5)** Depending on ambient temperature, see thermal derating diagram ([Output Power](#)).
- (6)** Not production tested. It is a design parameter.
- (7)** Test voltage as defined by the UL62368-1.
- (8)** Overload current, see [Duty Cycle I_{MOC} & Temperature Derating I_{MOC}](#).
- (9)** Within the complete V_{IN} operating range.
- (10)** Due to the converter topology, the external output voltage ripple frequency is twice the internal clock frequency.
- (11)** MIL-HDBK-217F; GB Ground, Benign: Non mobile, temperature and humidity controlled environments readily accessible to maintenance; includes laboratory instruments and test equipment, medical electronic equipment, business and scientific computer complexes, and missiles and support equipment in ground silos; MTBF value is referring to 1769205x41.

14 ISOLATION VOLTAGE

To verify the integrity of the isolation a test voltage is applied for a specified time across a component that is designed to provide electrical isolation. This test is known as 'High Pot Test', 'Flash Tested', 'Withstand Voltage', 'Proof Voltage', 'Dielectric Withstand Voltage' or 'Isolation Test Voltage'.

All isolated Power Modules are 100% production tested at their stated isolation voltage. This is 3 kVDC for 60 seconds.

The isolation test voltage indicated in this data sheet is for voltage transient immunity only. It does not allow this part to be used within a safety isolation system.

The module will function properly with several hundreds of volts applied continuously across the isolation barrier, however surrounding components must be individually analyzed to ensure proper insulation. Isolation measures must be taken into account to prevent any user-accessible circuitry from causing harm.

14.1 Dielectric Test Setup (High Pot Test)

Connect all input and output terminals together (see figure below) before connecting the supply voltage. When testing, set the cut-off current to 1mA with a test voltage of 3kVDC and test time of 60s.

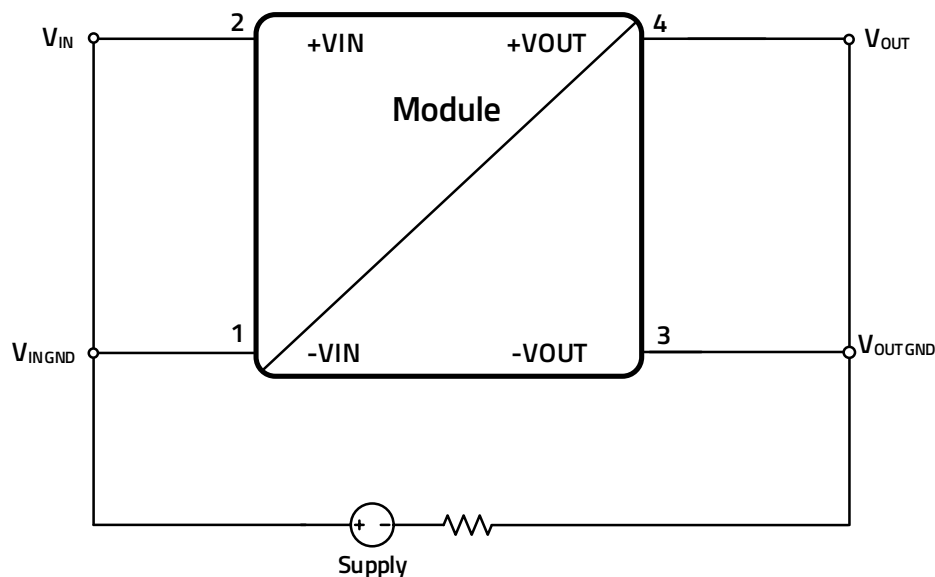


Figure 2: Dielectric test setup.

14.2 Repeated High-Voltage Isolation Testing

A repeated high voltage test of a barrier component degrades its isolation capabilities.

The primary and secondary windings within this transformer are enameled (coated) but do not possess additional isolation. Typically, parts can withstand multiples of their stated test voltage and still perform optimally. The magnet wire coating can degrade over time due to chemical reactions that occur at high voltages. We recommend keeping high voltage isolation testing to a minimum to better protect the isolation between the windings. If repeated high voltage isolation testing is required, consider reducing the voltage by a significant amount e.g. 20% from the test voltage stated within the datasheet

These safety concerns are equally applicable to components that utilize functional isolation beyond wire coating (i.e. physical barriers or spacing).

15 TYPICAL PERFORMANCE CURVES

If not otherwise specified, the following conditions apply: $T_A = 25^\circ\text{C}$.

15.1 Radiated and Conducted Emissions (With EMI Input Filter)

The 1769205x41 power modules were tested in several EMC configurations to give more realistic information about implementation in the applications. The test setup is based on CISPR16 with the limit values of CISPR32. All measurements were performed with the layout and components shown in [DESIGN EXAMPLE](#).

15.1.1 Radiated Emissions EN55032 (CISPR-32) Class B Compliant Test Setup

- Measured in a Fully Anechoic Room (FAR) at 3m antenna distance
- Input wire length: 160cm (80cm horizontal + 80cm vertical)
- Output wire length: 1m

15.1.2 Conducted Emissions EN55032 (CISPR-32) Class B Compliant Test Setup

- Measurement input wire length: 80cm
- Output wire length: 1m

15.1.3 Radiated And Conducted Emissions - 1769205041

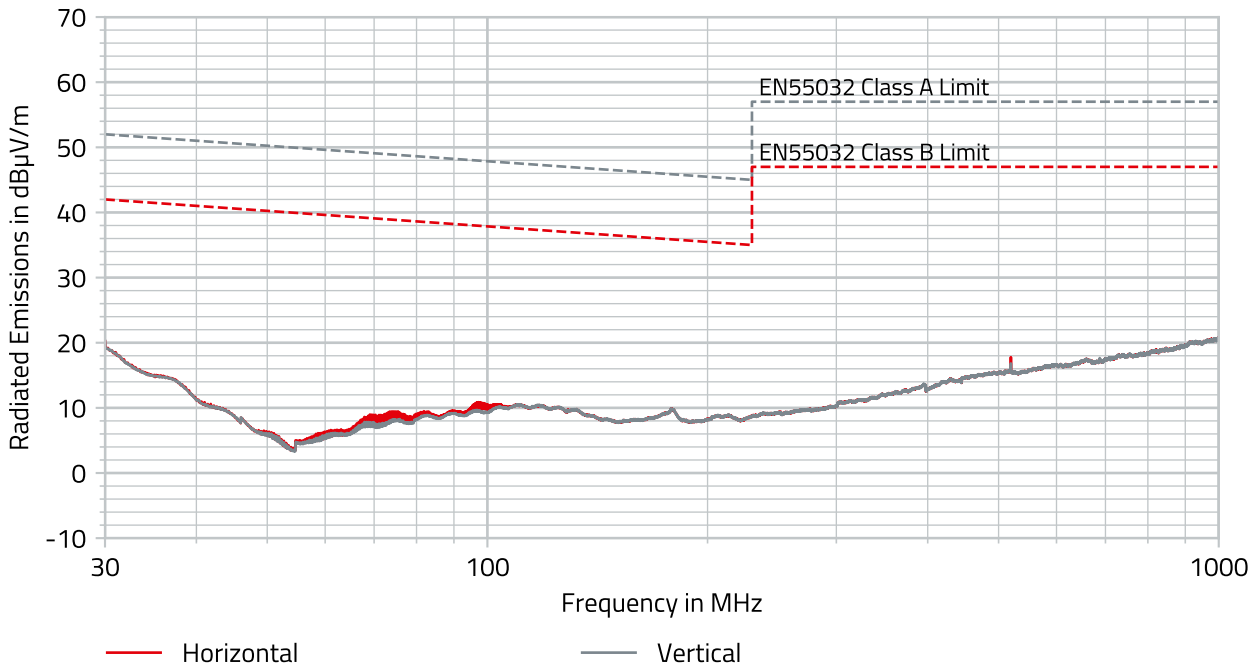


Figure 3: 1769205041 radiated EMI $V_{IN} = 3.3V$, $V_{OUT} = 5V$, $I_{OUT} = 0.2A$, with input filter.

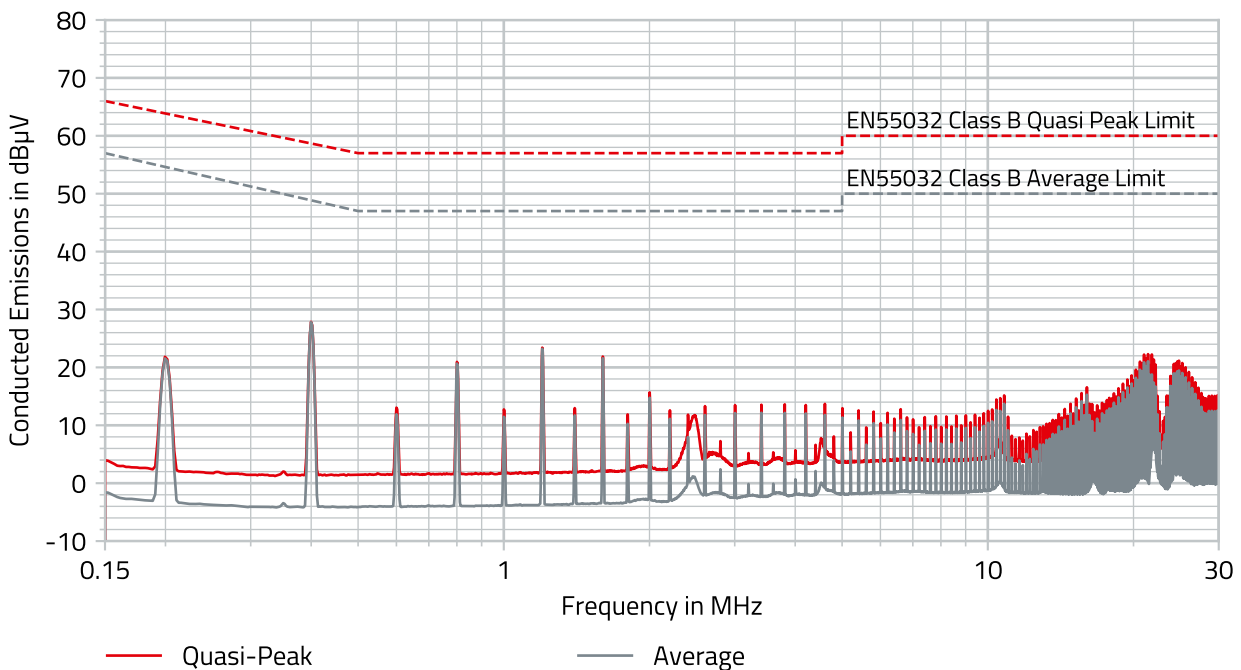


Figure 4: 1769205041 conducted EMI $V_{IN} = 3.3V$, $V_{OUT} = 5V$, $I_{OUT} = 0.2A$, with input filter.

15.1.4 Radiated And Conducted Emissions - 1769205141

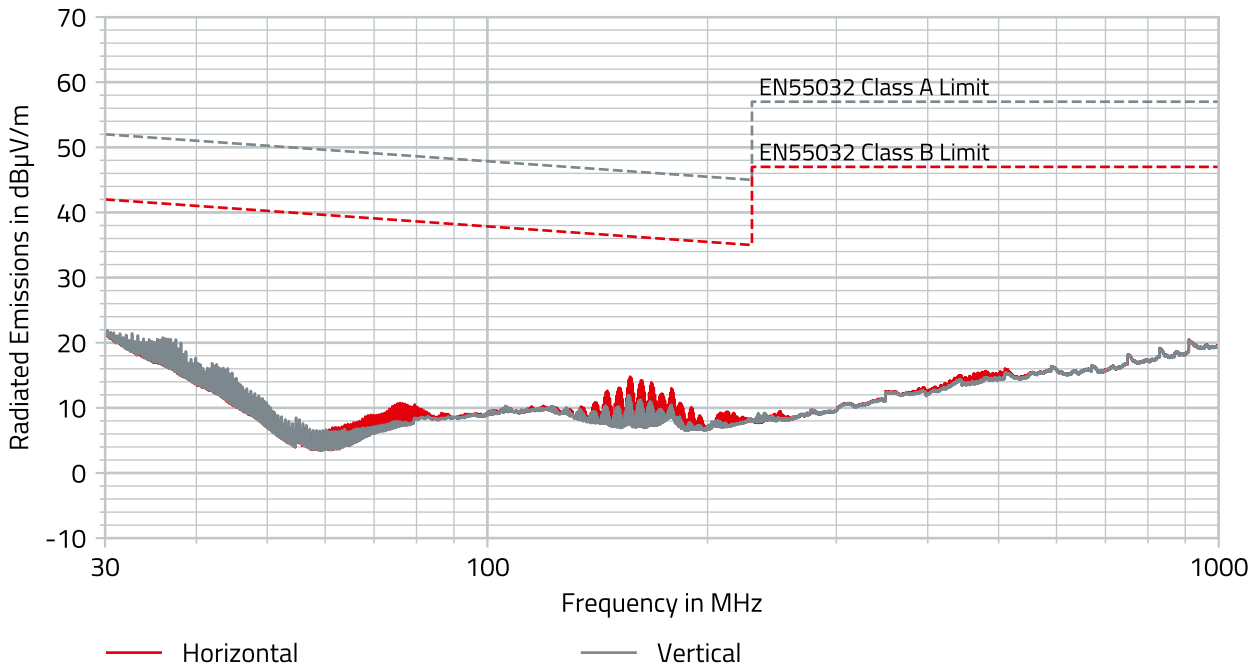


Figure 5: 1769205141 radiated EMI $V_{IN} = 5V$, $V_{OUT} = 5V$, $I_{OUT} = 0.2A$, with input filter.

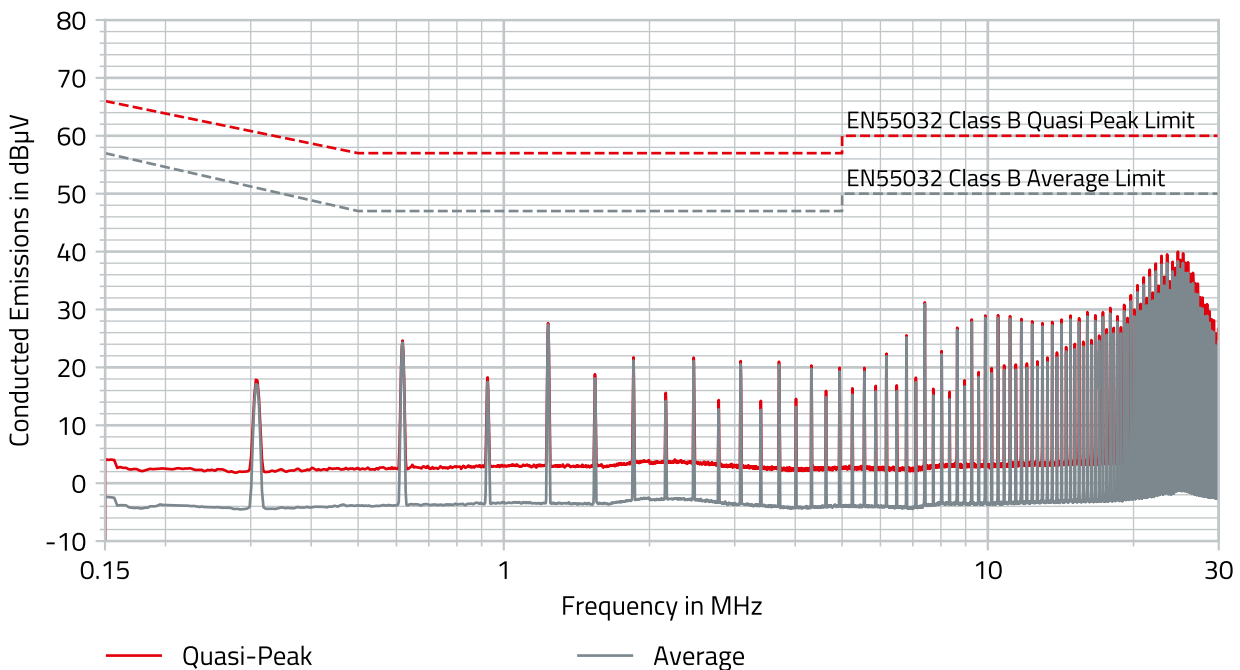


Figure 6: 1769205141 conducted EMI $V_{IN} = 5V$, $V_{OUT} = 5V$, $I_{OUT} = 0.2A$, with input filter.

15.1.5 Radiated And Conducted Emissions - 1769205241

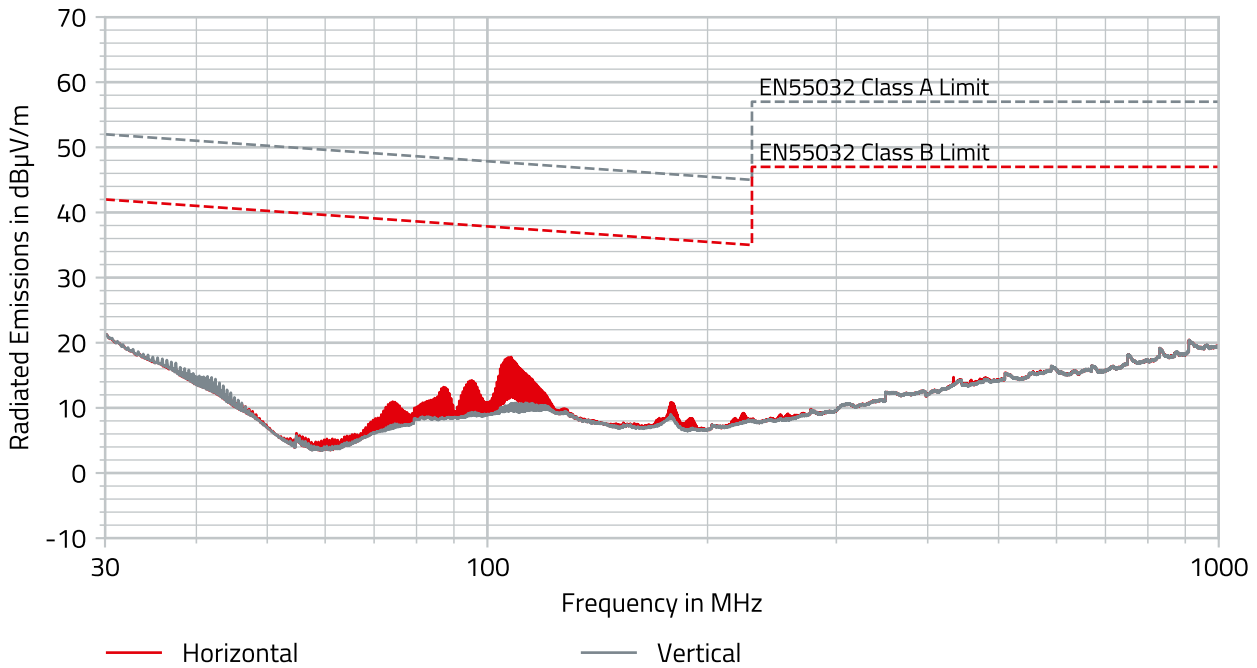


Figure 7: 1769205241 radiated EMI $V_{IN} = 12V$, $V_{OUT} = 5V$, $I_{OUT} = 0.2A$, with input filter.

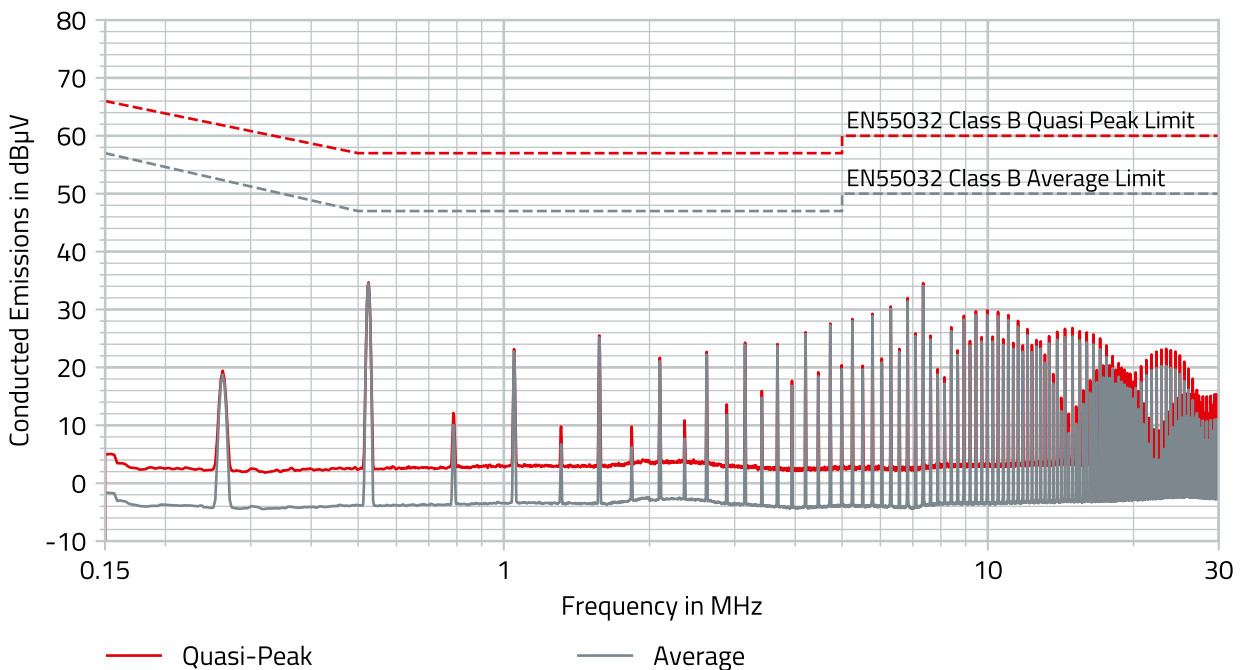


Figure 8: 1769205241 conducted EMI $V_{IN} = 12V$, $V_{OUT} = 5V$, $I_{OUT} = 0.2A$, with input filter.

15.1.6 Radiated And Conducted Emissions - 1769205341

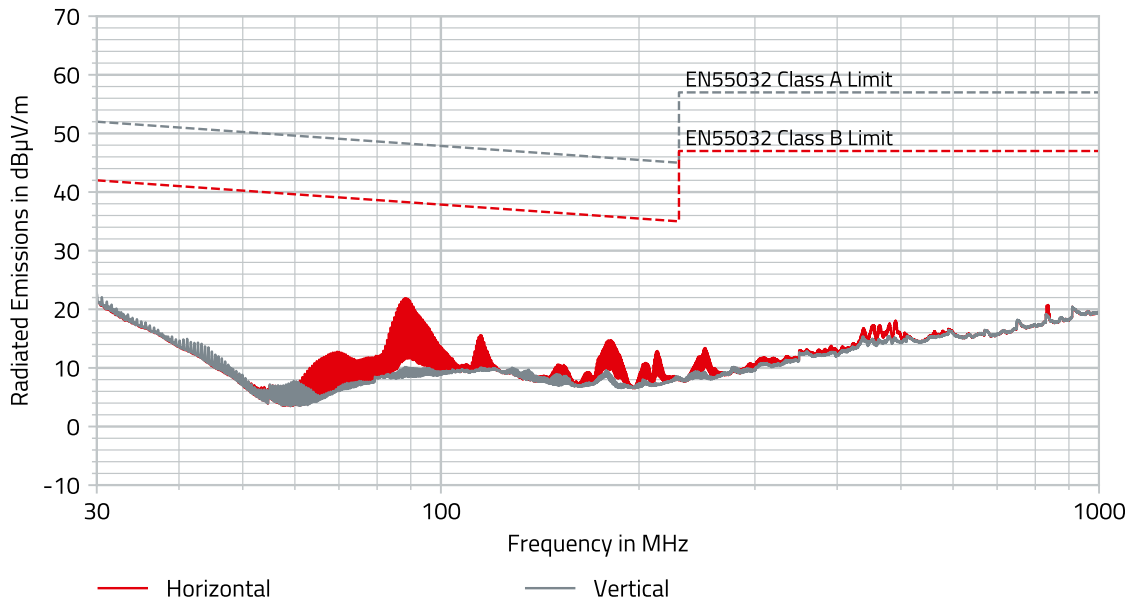


Figure 9: 1769205341 radiated EMI $V_{IN} = 24V$, $V_{OUT} = 5V$, $I_{OUT} = 0.2A$, with input filter.

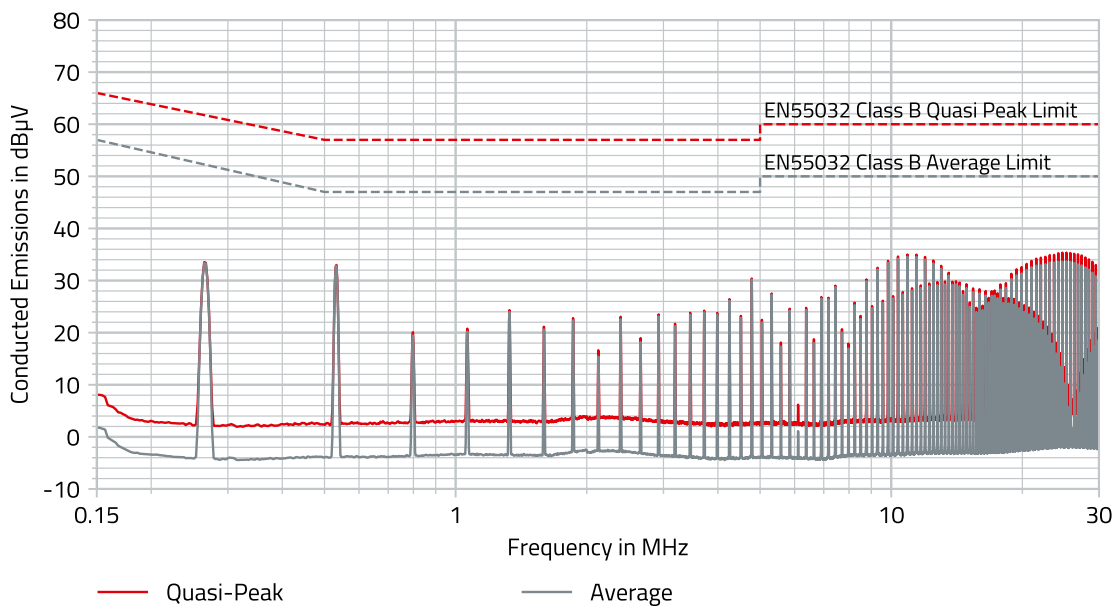


Figure 10: 1769205341 conducted EMI $V_{IN} = 24V$, $V_{OUT} = 5V$, $I_{OUT} = 0.2A$, with input filter.

15.2 DC Performance Curves

15.2.1 Efficiency

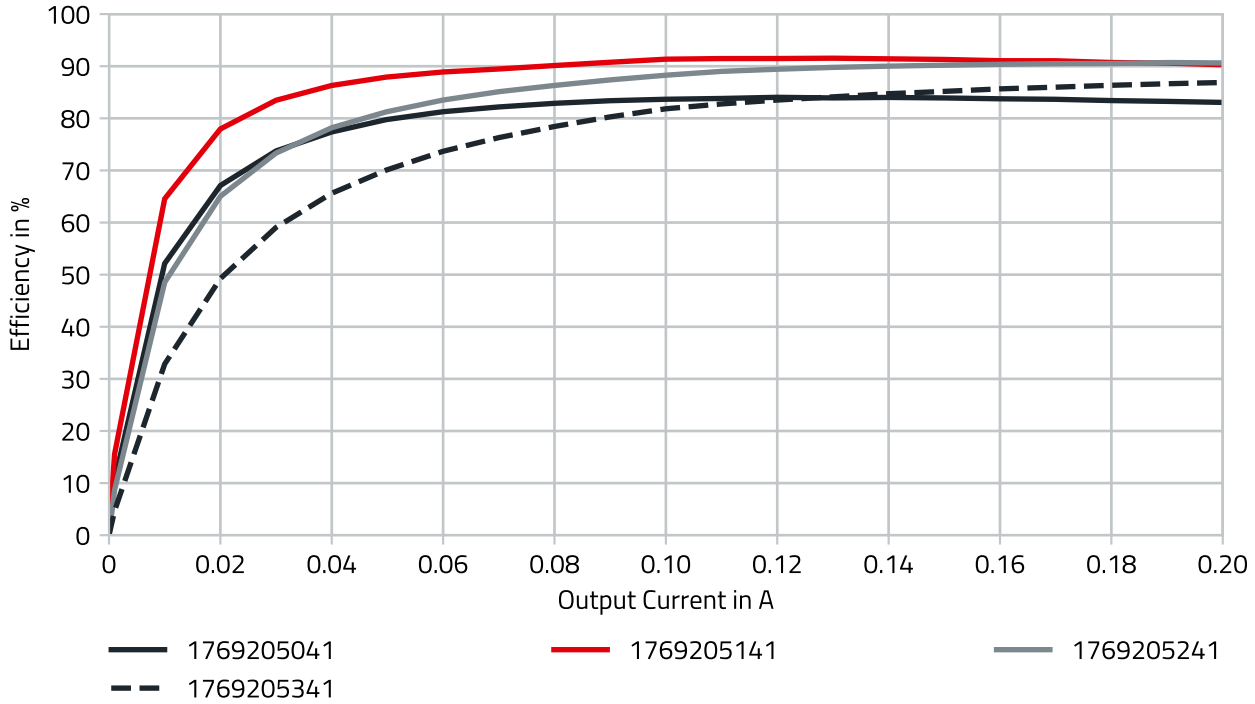


Figure 11: 1769205x41 efficiency, $V_{IN} = \text{Nom}$, $T_A = 25^\circ\text{C}$.

15.3 Output Power

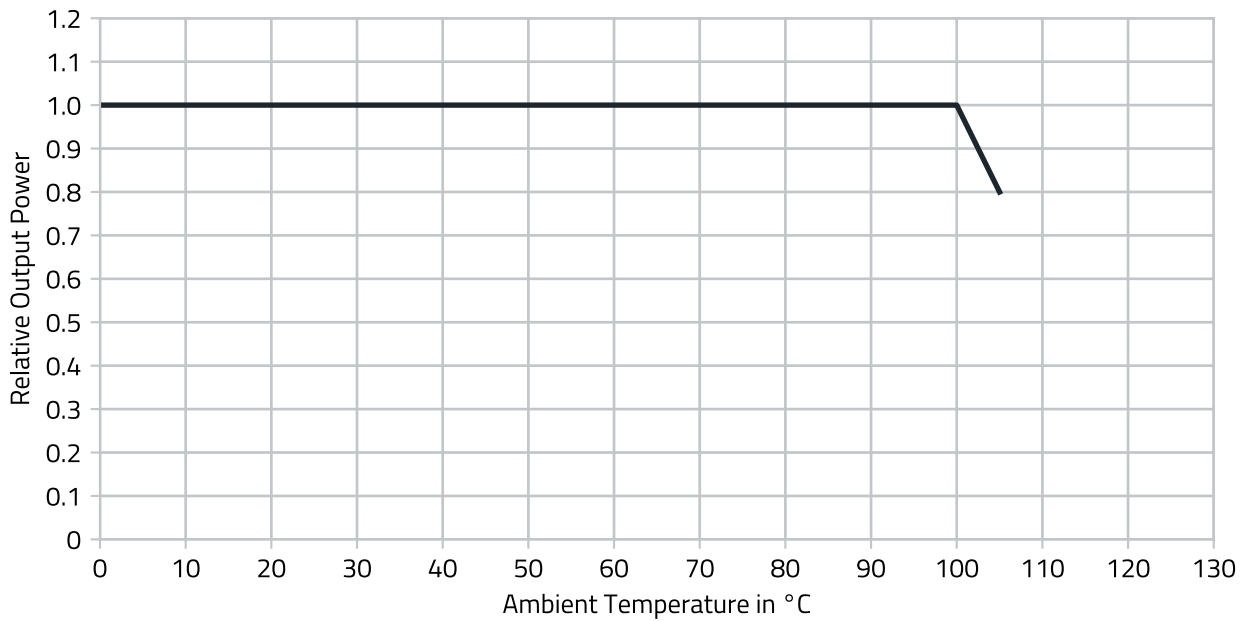


Figure 12: 1769205x41 output power thermal derating, $V_{IN} = \text{Nom.}$, $I_{OUT} = 0.2A$.

15.4 Duty Cycle I_{MOC}

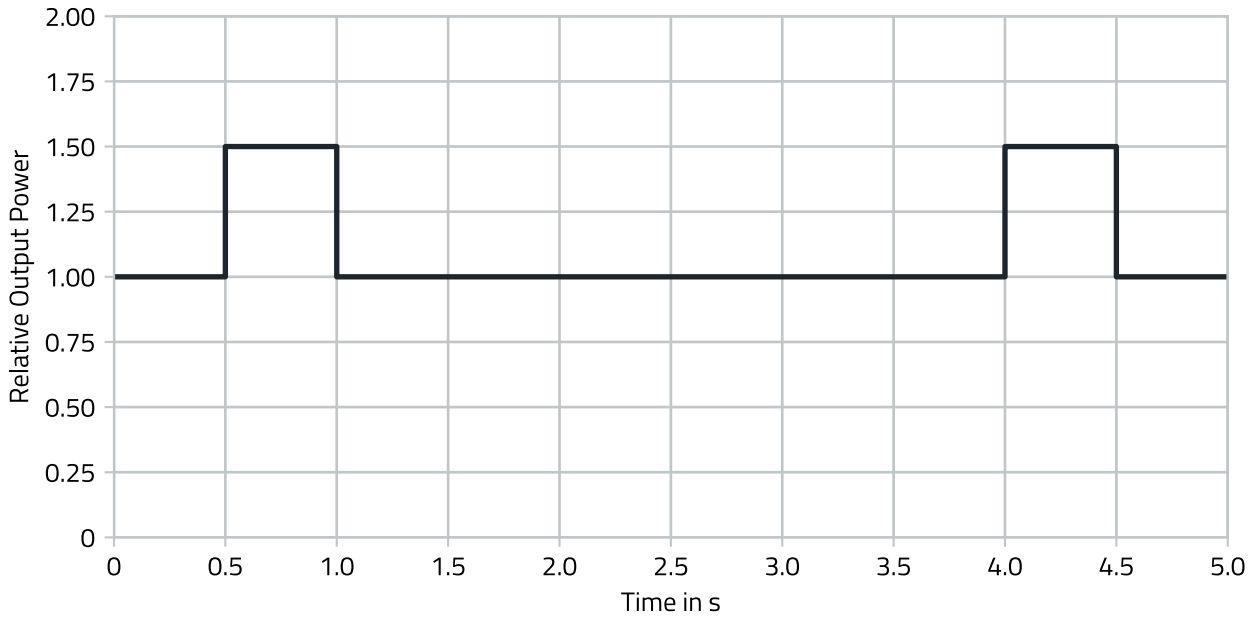


Figure 13: 1769205x41 dynamic power boost, $V_{IN} = \text{Nom.}$

The overload current of 150% I_{OUT} can be supplied for maximum 0.5s and requires a 3s recovery time until the next overload event.

15.4.1 Temperature Derating I_{MOC}

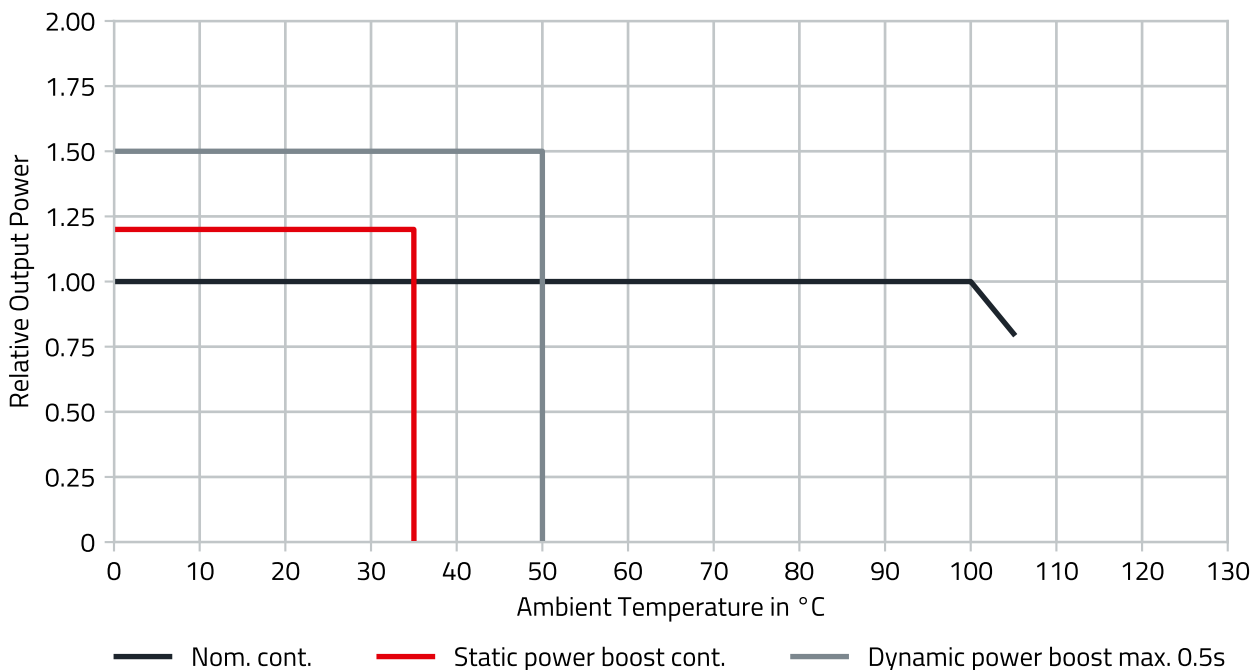


Figure 14: 1769205x41 power boost thermal derating, $V_{IN} = \text{Nom.}$

15.4.2 Output Voltage Tolerance Envelope

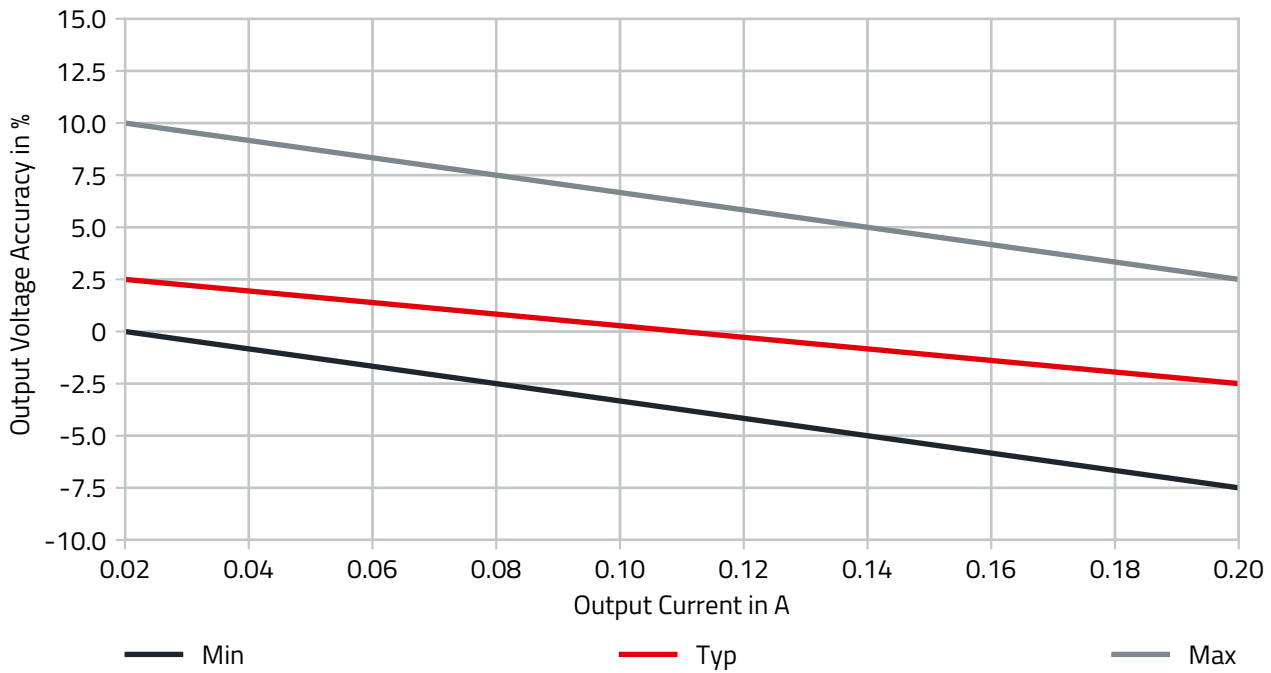


Figure 15: 1769205041, 1769205141 output voltage tolerance envelope, $V_{IN} = 3.3V/5V$.

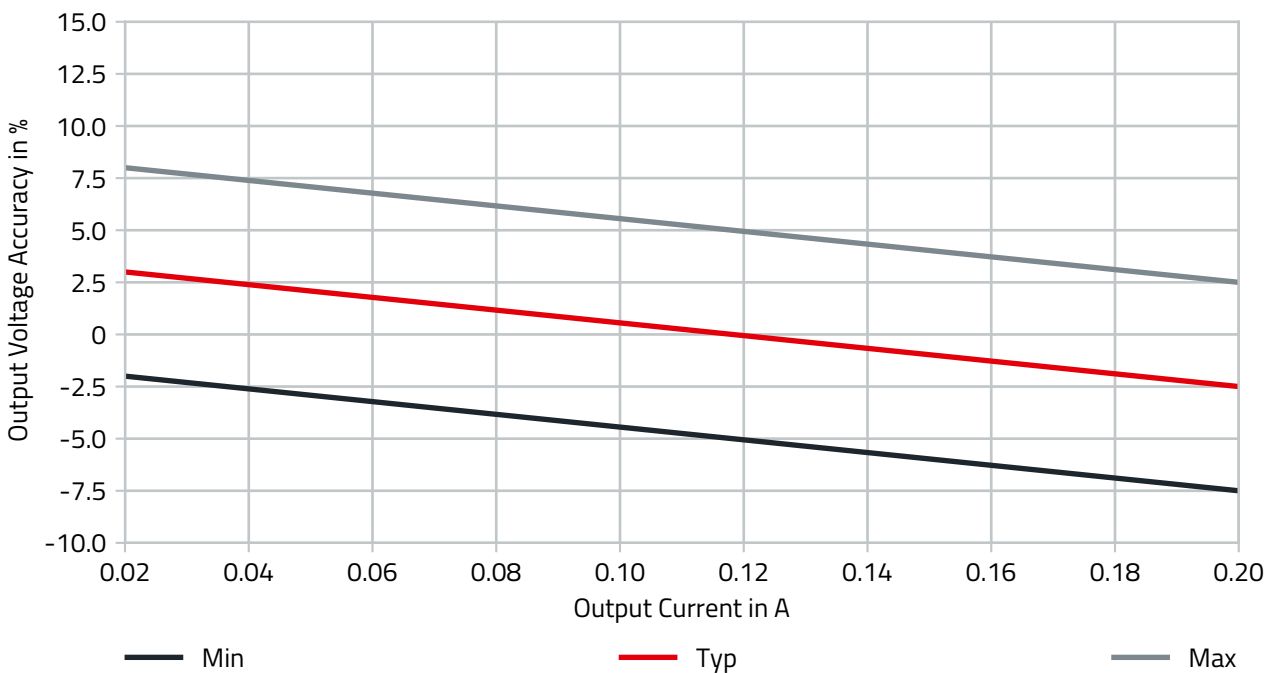


Figure 16: 1769205241, 1769205341 output voltage tolerance envelope, $V_{IN} = 12V/24V$.

16 BLOCK DIAGRAM

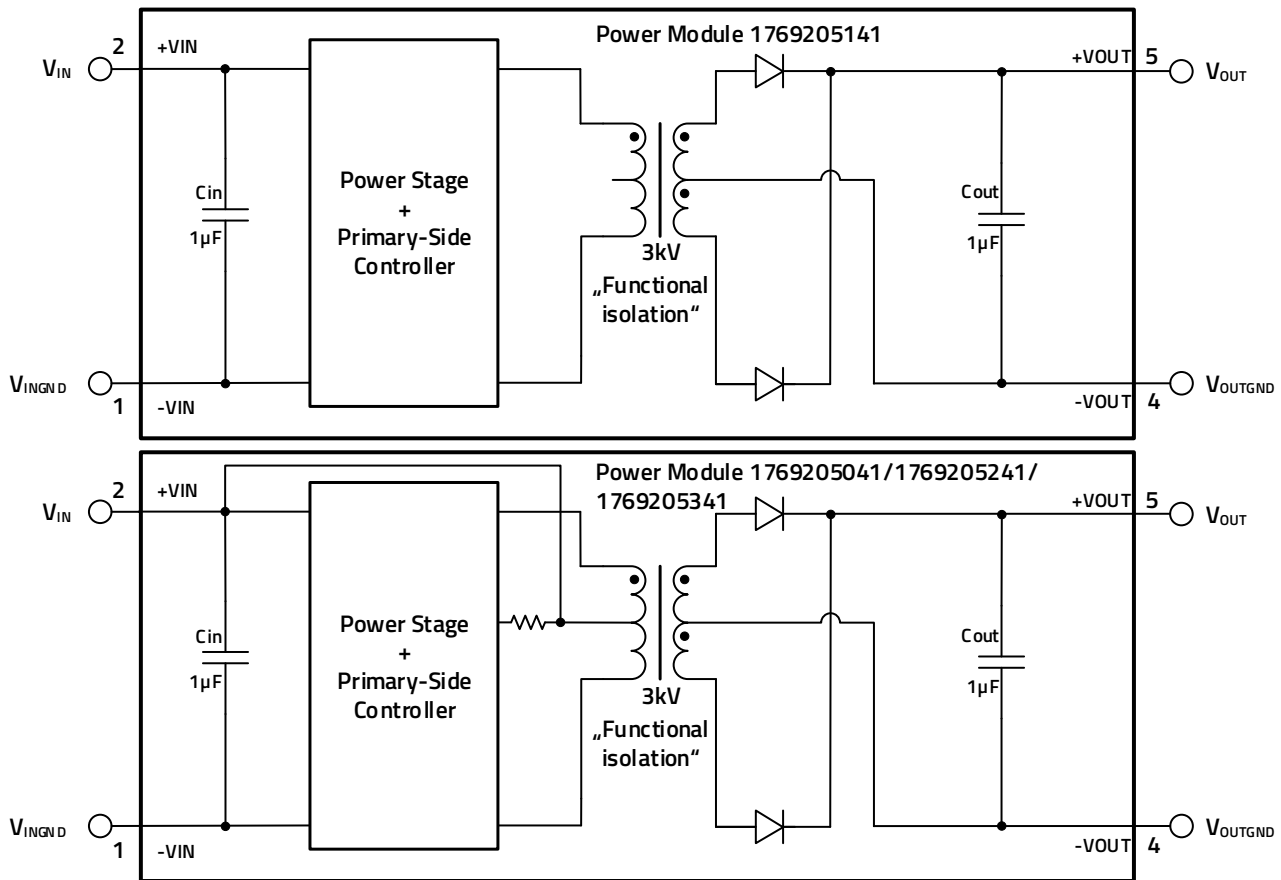


Figure 17: 1769205x41 block Diagram.

17 CIRCUIT DESCRIPTION

The MagI³C power module 1769205141 is based on full bridge topology whereas the MagI³C power modules 1769205041 / 1769205241 / 1769205341 are based on a push-pull converter. All modules have an integrated IC, rectifying diodes, input and output capacitors and a transformer.

Since there is no feedback path from the output to the input, the duty cycle is fixed at 50% and is independent of the load (zero load to full load). The output voltage is unregulated and defined by the turns ratio of the transformer.

18 PROTECTION FEATURES

18.1 Short-Circuit Protection (SCP)

The modules are continuously output short-circuit protected. The protection is realized via comparing the drain voltages of the MOSFETs to a certain internal reference. During a short circuit situation the output voltage is pulled low. The output voltage recovers to its nominal value after the error is resolved.

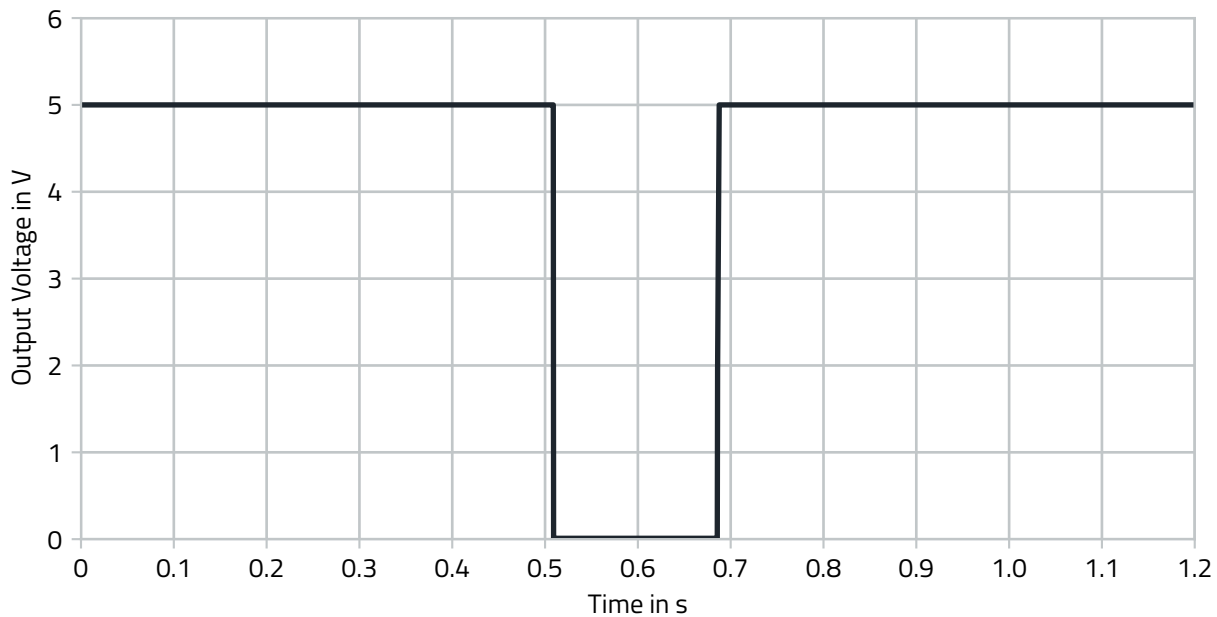


Figure 18: 1769205x41 short-circuit protection nominal V_{IN} / V_{OUT} , $I_{OUT} = 0.2A$.

19 DESIGN EXAMPLE

The design example shows a possible solution for 3.3V (1769205041), 5V (1769205141), 12V (1769205241) and 24V (1769205341) to 5V with a max. I_{out} of 0.2A. All of the necessary components to fulfill the requirements of the CISPR 32 EMI conducted- and radiated-emissions tests are included in the design example. It passes the conducted emissions class B with 0.8m input- and 1m output lines and passes the radiated emissions class B in a FAR at 3m measurement distance with 0.8m horizontal, 0.8m vertical input- and 1m horizontal outputlines. In the final application filter components may be omitted depending on the requirements.

19.1 Layout

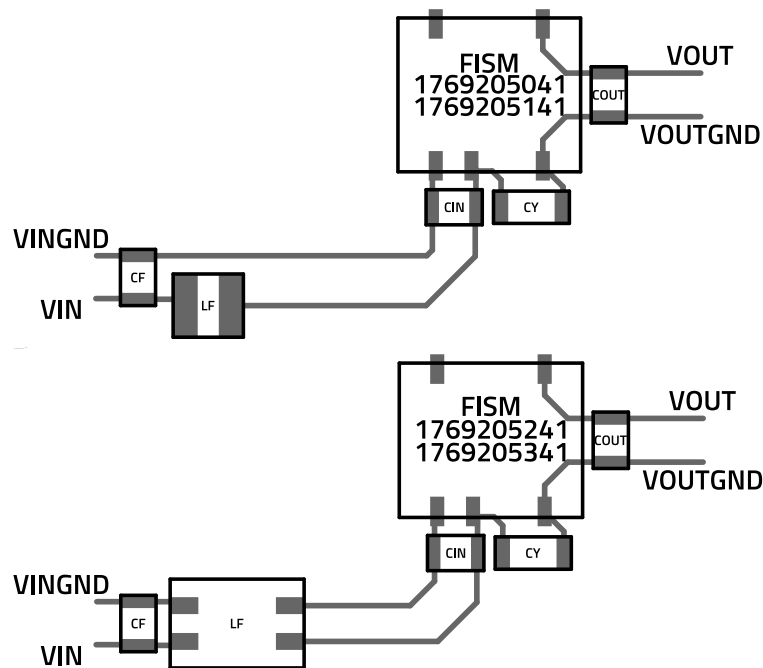


Figure 19: 1769205x41 layout recommendation.

The layout above has been evaluated to provide the optimal performance in terms of transient response, efficiency, ripple and EMI. The design footprint can be reduced at the expense of performance in these parameters. The following recommendation should be followed when designing the layout:

1. The input capacitor should be placed as close as possible to the +VIN and -VIN pins of the device.
2. The output capacitor should be placed as close as possible to the +VOUT and -VOUT pins of the device.
3. The Y-capacitor should be placed as close as possible to the +VIN and -VOUT pins of the device.

19.2 Schematic

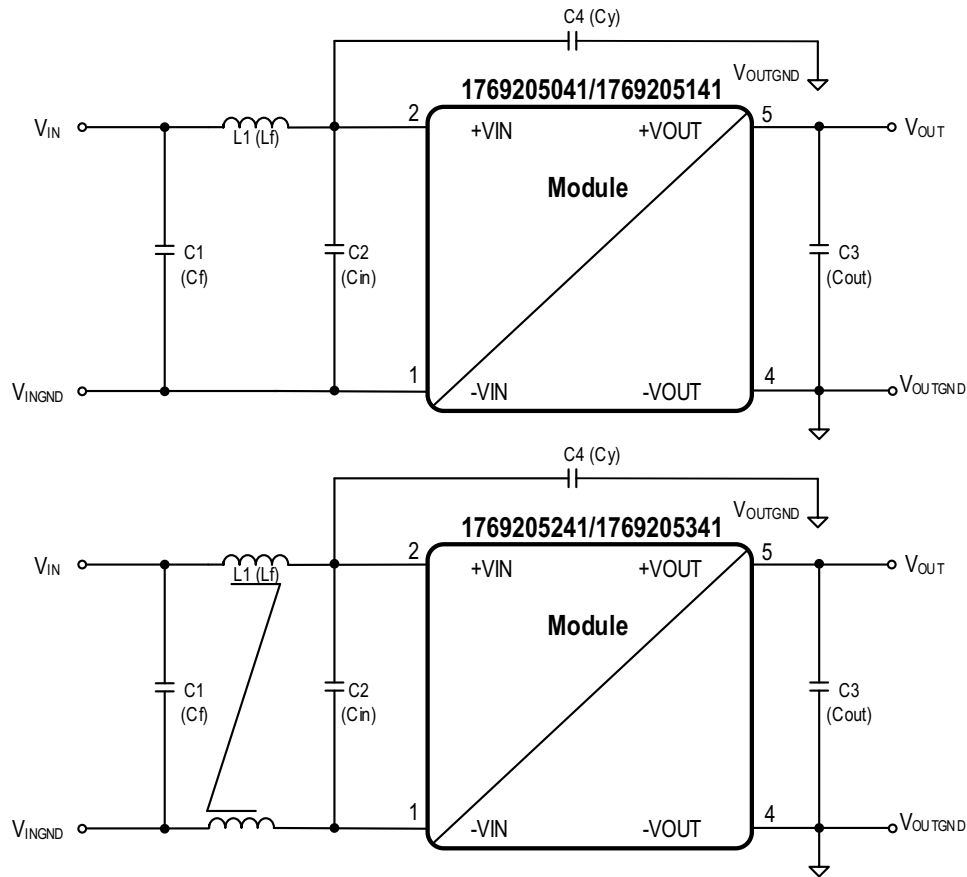


Figure 20: 1769205x41 design example schematic.

19.3 Bill of Materials

19.3.1 Module: 1769205041 / 1769205141 (3.3V / 5V Input / 5V Output / 0.2A)

Table 13: 1769205041 / 1769205141 design example bill of materials.

| DESIGNATOR | DESCRIPTION | FUNCTION | QUANTITY | ORDER CODE | MANUFACTURER |
|------------|---|--|----------|---------------------------|--------------|
| U1 | Magl ³ C Power Module | Power supply | 1 | 1769205041/ 1769205141 | WE |
| L1 | Filter inductor, 6.8μH, PD2 family, I _{SAT} = 2.1A, I _R = 1.54A | Input Filter | 1 | 744773068 | WE |
| C1 | Ceramic chip capacitor 4.7μF/10V X7R, 1210 | Input Filter | 1 | 885012209004 | WE |
| C2 | Ceramic chip capacitor 4.7μF/10V X7R, 1210 | Input Filter / Electrical Performance | 1 | 885012209004 | WE |
| C3 | Ceramic chip capacitor 10μF/16V X7R, 1210 | Output Filter / Electrical Performance | 1 | 885012209014 | WE |
| C4 | Ceramic chip capacitor 470pF/3kV Impulse 1808 X7R | Y-Cap | 1 | 885342210003 | WE |

19.3.2 Module: 1769205241 (12V Input / 5V Output / 0.2A)

Table 14: 1769205241 design example bill of materials.

| DESIGNATOR | DESCRIPTION | FUNCTION | QUANTITY | ORDER CODE | MANUFACTURER |
|------------|--|--|----------|--------------|--------------|
| U1 | MagI ³ C Power Module | Power supply | 1 | 1769205241 | WE |
| L1 | Filter inductor (cmc), 10μH, SL2 family, I _R = 1.6A | Input Filter | 1 | 744226S | WE |
| C1 | Ceramic chip capacitor 4.7μF/16V X7R, 1210 | Input Filter | 1 | 885012209013 | WE |
| C2 | Ceramic chip capacitor 4.7μF/16V X7R, 1210 | Input Filter / Electrical Performance | 1 | 885012209013 | WE |
| C3 | Ceramic chip capacitor 10μF/16V X7R, 1210 | Output Filter / Electrical Performance | 1 | 885012209014 | WE |
| C4 | Ceramic chip capacitor 470pF/3kV Impulse 1808 X7R | Y-Cap | 1 | 885342210003 | WE |

19.3.3 Module: 1769205341 (24V Input / 5V Output / 0.2A)

Table 15: 1769205341 design example bill of materials.

| DESIGNATOR | DESCRIPTION | FUNCTION | QUANTITY | ORDER CODE | MANUFACTURER |
|------------|--|--|----------|--------------|--------------|
| U1 | MagI ³ C Power Module | Power supply | 1 | 1769205341 | WE |
| L1 | Filter inductor (cmc), 10μH, SL2 family, I _R = 1.6A | Input Filter | 1 | 744226S | WE |
| C1 | Ceramic chip capacitor 4.7μF/50V X7R, 1210 | Input Filter | 1 | 885012209048 | WE |
| C2 | Ceramic chip capacitor 4.7μF/50V X7R, 1210 | Input Filter / Electrical Performance | 1 | 885012209048 | WE |
| C3 | Ceramic chip capacitor 10μF/16V X7R, 1210 | Output Filter / Electrical Performance | 1 | 885012209014 | WE |
| C4 | Ceramic chip capacitor 470pF/3kV Impulse 1808 X7R | Y-Cap | 1 | 885342210003 | WE |

20 APPLICATION CONSIDERATIONS

20.1 Primary Side Parallel Connection

A standard industrial configuration is, that the power modules are supplied by a dc bus voltage. Multiple 1769205x41 can be connected to one dc bus as shown in the figure below.

The outputs must not be connected in parallel to each other and could have individual voltages V_{OUT1} and V_{OUT2} . For serial connection of the output see also '[Secondary Side Serial Connection](#)'.

In case of using long supply lines or different wire length for each 1769205x41 it is recommended to decouple each power module with an additional LC filter (see schematic below). The decoupling LC filter is also recommended if the supplying dc bus has a high impedance so that high voltage swings at the input of each power module might be present.

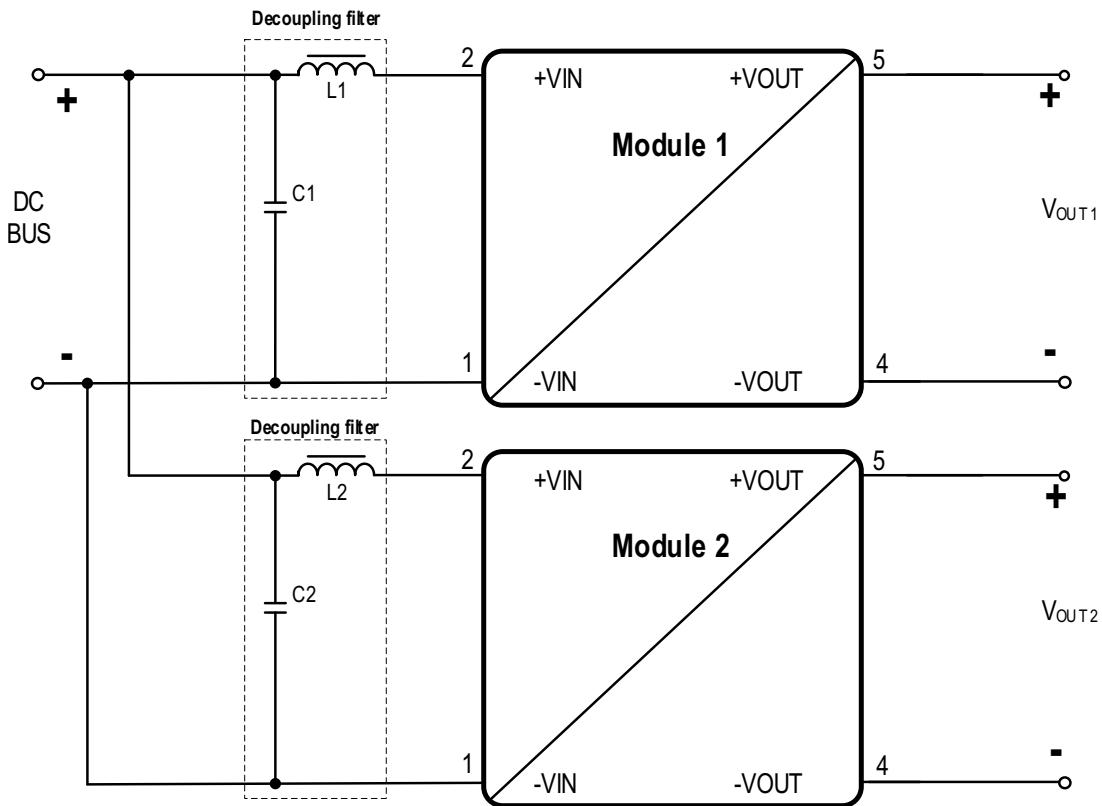


Figure 21: Decoupling for primary side parallel connection.

As a starting point for the decoupling filters, use the values of the reference filters - see also '[Radiated And Conducted Emissions \(With Input Filter\)](#)'. The final appropriate filter for the application has then to be evaluated under operation in the target application by checking e.g. the change of the input ripple voltage.

20.2 Secondary Side Serial Connection

To generate a higher output voltage it is possible to put the outputs of the 1769205x41 in series. It is common practice to connect an additional capacitor between the +VOUT and -VOUT.

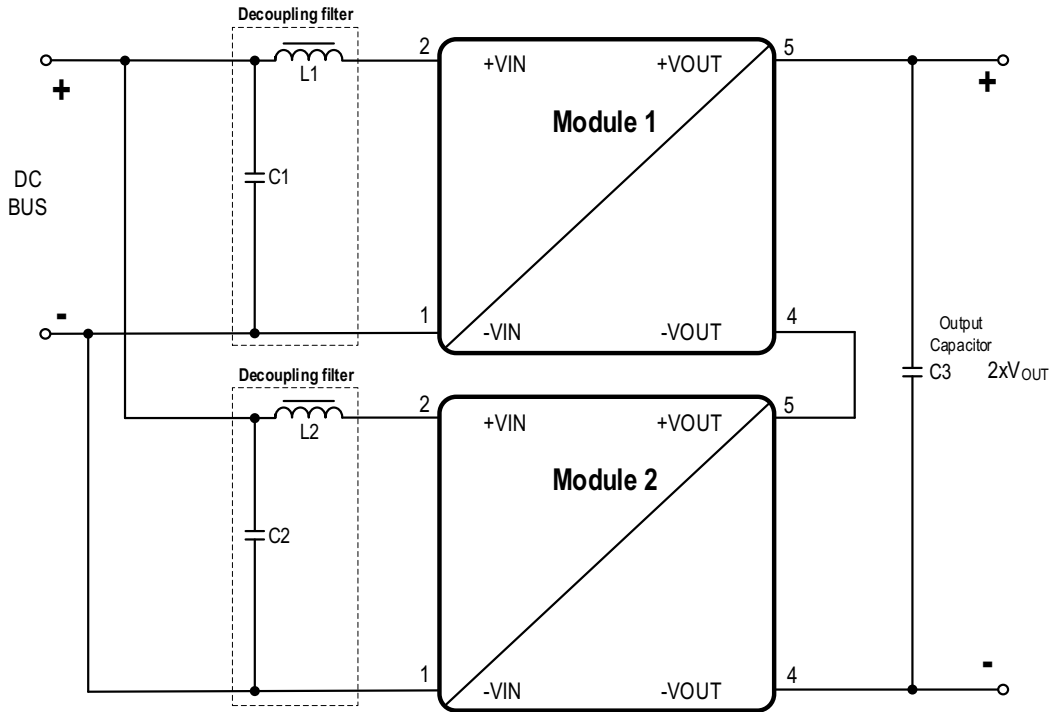


Figure 22: Primary side serial connection.

In case of using long supply lines or different line length for each 1769205x41 it is recommended to decouple each power module with an additional LC filter. The decoupling LC filter is also recommended if the supplying dc bus has a high impedance so that high voltage swings at the input of each power module could be present. As initial values, the EMI filter shown for every part number can be used. See also '[Primary Side Parallel Connection](#)'.

20.3 Generating Complementary Output Voltages

Another common requirement in industrial applications is to provide a complementary voltage ($\pm 5V$). This can be easily implemented by using two 1769205x41 modules according to the schematic below. It is a common practice to connect an additional capacitor across each output voltage.

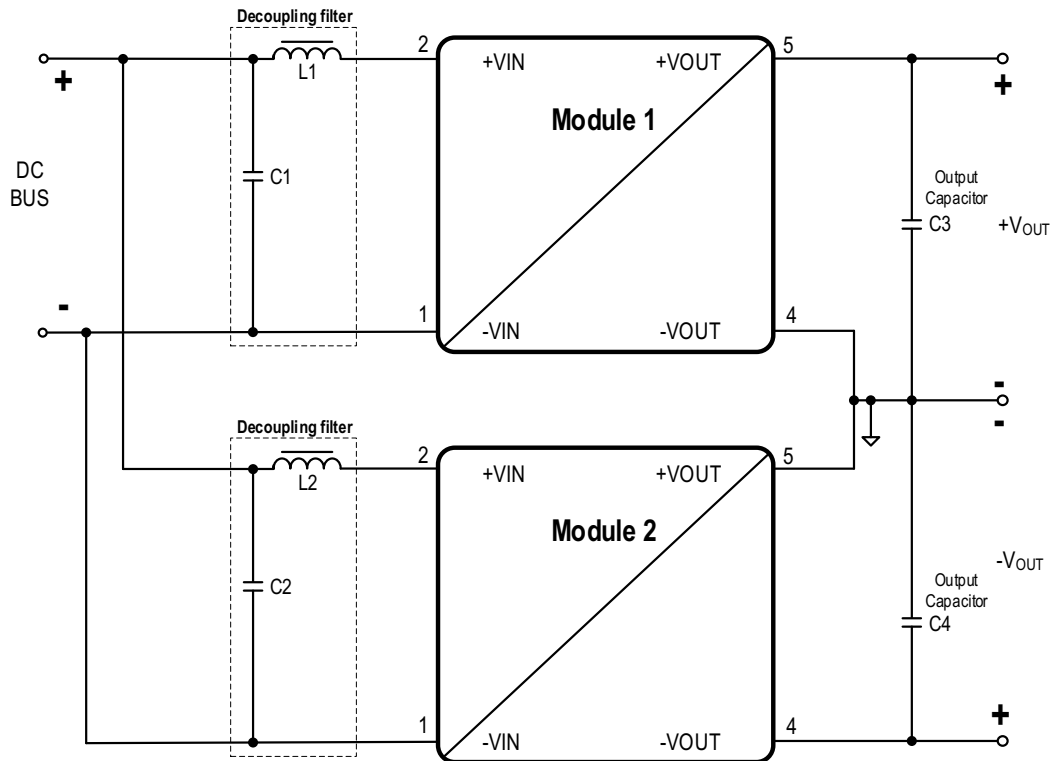


Figure 23: Generating complementary output voltages.

For using long supply lines or different line length for each 1769205x41 it is recommended to decouple each power module with an additional LC- filter. The decoupling LC filter is also recommended if the supplying dc bus has a high impedance so that high voltage swings at the input of each power module could be present. As initial values, the EMI filter shown for every part number can be used. See also '[Primary Side Parallel Connection](#)'.

20.4 Reverse Polarity Protection

A simple way of creating an input reverse polarity protection is to place a diode in series with the positive input line. Due to the forward voltage drop of the diode the application efficiency drops.

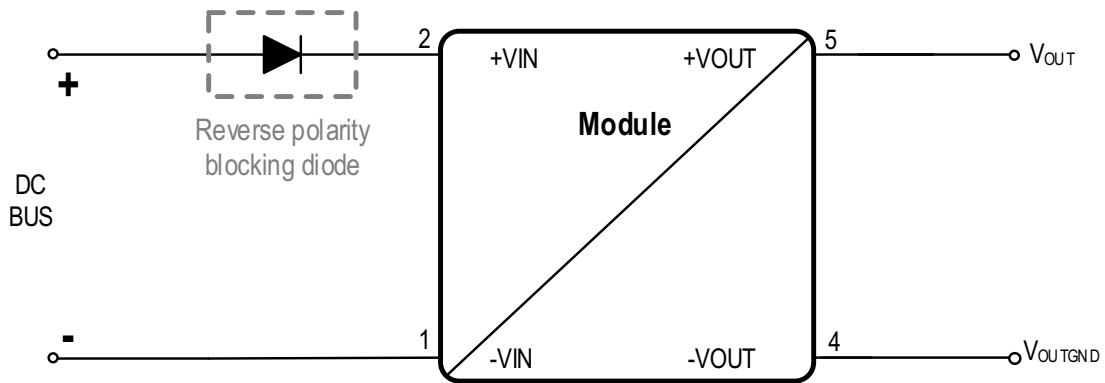


Figure 24: Reverse polarity protection.

21 HANDLING RECOMMENDATIONS

1. The power module is classified as MSL1 (JEDEC Moisture Sensitivity Level 1) and doesn't require special handling due to moisture sensitivity (JEDEC J-STD033).
2. Parts have unlimited floor life according to JEDEC J-STD033.
3. Maximum numbers of reflow cycles is two.
4. For minimum risk, solder the module in the last reflow cycle of the PCB production.
5. The component lead material is copper (Cu) and the lead finish is ENEPIG (NiPdAu).
6. For solder paste use a standard SAC Alloy such as SAC 305, type 3 or higher.
7. The profile below is valid for convection reflow only
8. Other soldering methods (e.g. vapor phase) are not verified and have to be validated by the customer at their own risk

21.1 Soldering Profile

Table 16: Reflow solder profile.

| Profile Feature | Symbol | Value |
|--|--------------|-----------------------|
| Preheat temperature minimum | T_{s_min} | 150°C |
| Preheat temperature maximum | T_{s_max} | 180°C |
| Preheat time from T_{s_min} to T_{s_max} | t_s | 60-90 seconds |
| Liquidous temperature | T_L | 217°C |
| Time maintained above T_L | t_L | 60-90 seconds |
| Classification temperature | T_C | 245°C |
| Peak package body temperature | T_P | $T_P \leq T_C$ |
| Time within $T_C - 5^\circ\text{C}$ and T_C | t_p | $t_p \leq 20$ seconds |
| Ramp-up Rate (T_L to T_P) | | 3°C/second maximum |
| Ramp-down rate (T_P to T_L) | | 3°C/second maximum |
| Time 25°C to peak temperature | | 8 minutes maximum |

Please refer to JEDEC J-STD020 for further information pertaining to reflow soldering of electronic components.

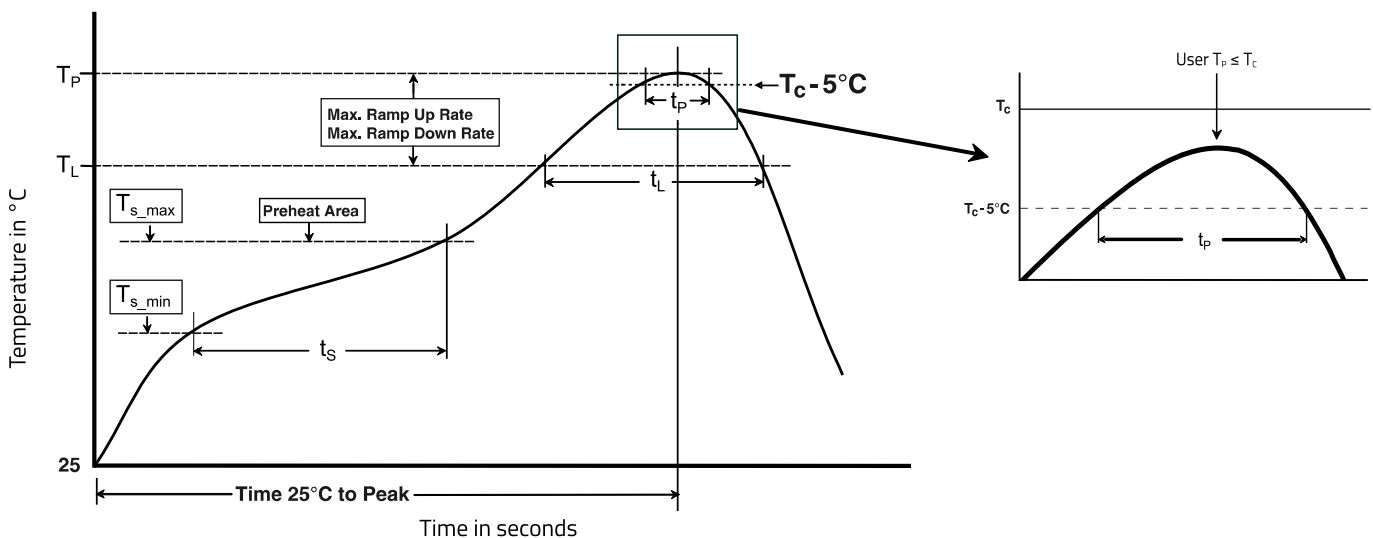


Figure 25: Solder profile.

22 PHYSICAL DIMENSIONS

22.1 Component

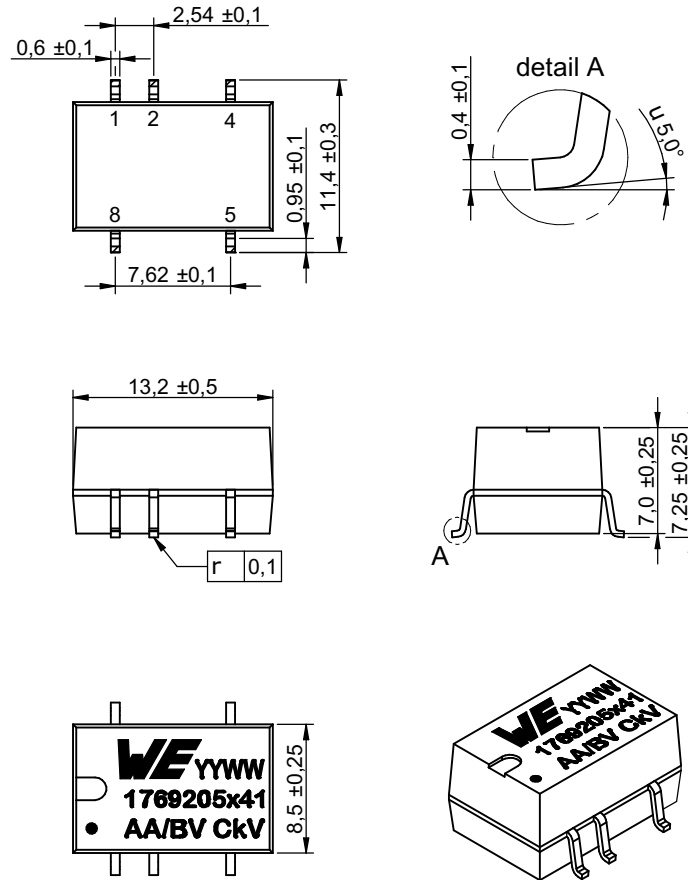


Figure 26: Physical dimensions.

All dimensions in mm Tolerance: xx.x = ±0.5mm ; xx.xx = ±0.25mm unless otherwise noted

22.2 Recommended Landpattern

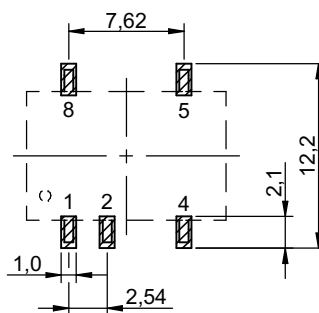


Figure 27: Recommended landpattern dimensions.

22.3 Packaging

Tape and Reel (mm)

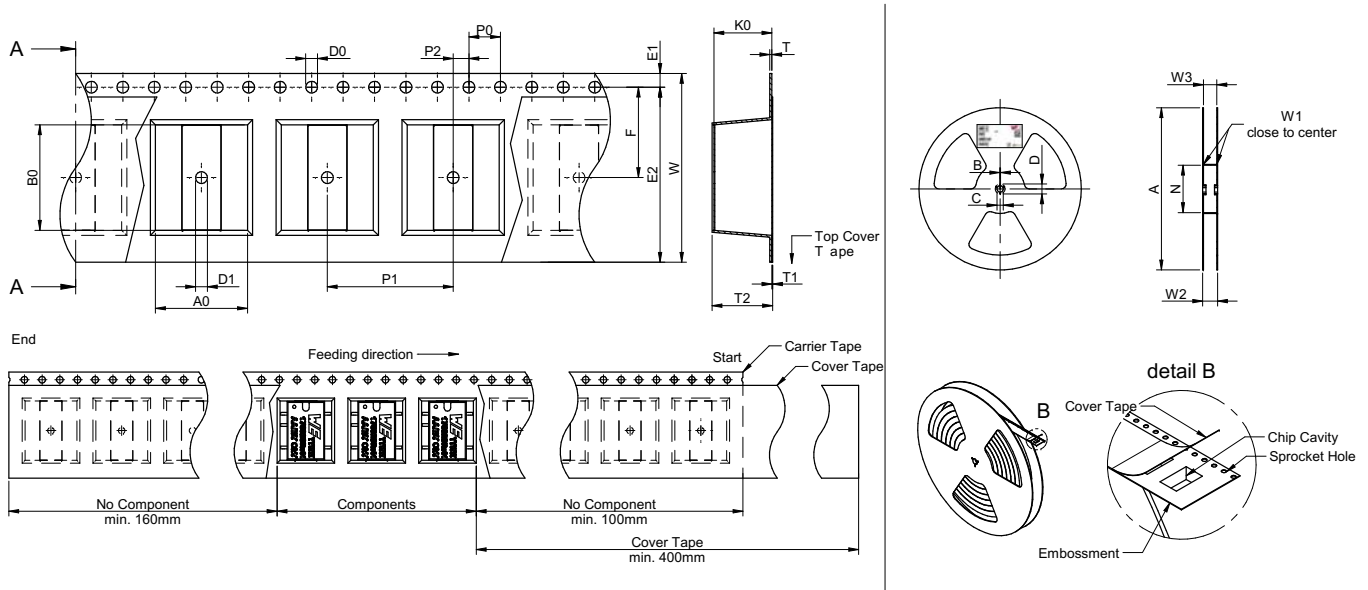


Figure 28: Packaging dimensions.

Table 17: Tape dimensions.

| A0 | B0 | D0 / D1 | E1 | E2 | K0 | P0 | P1 | P2 | T | T1 | T2 | W |
|-------|-------|---------|-------|-------|-------|-------|-------|-------|------|------|-------|-------|
| ±0.10 | ±0.10 | ±0.10 | ±0.10 | ±0.10 | ±0.10 | ±0.10 | ±0.10 | ±0.05 | | | ±0.10 | ±0.10 |
| 11.70 | 13.10 | 1.50 | 1.75 | 22.25 | 7.50 | 4.00 | 16.00 | 2.00 | 0.50 | 0.35 | 8.00 | 24.00 |

Tape material is polystyrene

Table 18: Reel dimensions.

| A | B | C | D | N | W1 | W2 | W3 |
|--------|-------|-------|-------|--------|----------------|-------|----------------|
| ±2.0 | ±0.30 | ±0.20 | ±0.50 | ±1.00 | +1.00 -0.50 | ±2.00 | +1.00 -0.50 |
| 330.00 | 2.30 | 13.00 | 21.00 | 100.00 | 24.5 | 28.50 | 24.50 |

23 DOCUMENT HISTORY

Table 19: Document history.

| Revision | Date | Description | Comment |
|----------|-------------|-------------------------------|---|
| 1.0 | April 2022 | Initial release of data sheet | |
| 2.0 | August 2023 | PCN, Major change | To improve the processability, Würth Elektronik has expanded the reflow solder profile to align with the JEDEC J-STD020E industry standard for reflow soldering. As a datasheet information amendment, Würth Elektronik has changed the specified switching frequency to create a better understanding between the internal and external switching frequency of the topology and to justify the shown EMC diagrams. This is a datasheet correction only. There will be no change in form, fit, function, quality or reliability of the product. All date codes will be affected by this change. |
| 2.1 | August 2023 | Minor change | Family expansion, release of 1769205041 |

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26 CAUTIONS AND WARNINGS

The following conditions apply to all goods within the product series of MagI³C of Würth Elektronik eiSos GmbH & Co. KG:

General:

- All recommendations according to the general technical specifications of the data-sheet have to be complied with.
- The usage and operation of the product within ambient conditions which probably alloy or harm the component surface has to be avoided.
- The responsibility for the applicability of customer specific products and use in a particular customer design is always within the authority of the customer. All technical specifications for standard products do also apply for customer specific products
- Residual washing varnish agent that is used during the production to clean the application might change the characteristics of the body, pins or termination. The washing varnish agent could have a negative effect on the long term function of the product. Direct mechanical impact to the product shall be prevented as the material of the body, pins or termination could flake or in the worst case it could break. As these devices are sensitive to electrostatic discharge customer shall follow proper IC Handling Procedures.
- Customer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of Würth Elektronik eiSos GmbH & Co. KG components in its applications, notwithstanding any applications-related information or support that may be provided by Würth Elektronik eiSos GmbH & Co. KG.
- Customer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences lessen the likelihood of failures that might cause harm and take appropriate remedial actions
- Customer will fully indemnify Würth Elektronik eiSos and its representatives against any damages arising out of the use of any Würth Elektronik eiSos GmbH & Co. KG components in safety-critical applications

Product specific:

Follow all instructions mentioned in the datasheet, especially:

- The solder profile has to comply with the technical reflow or wave soldering specification, otherwise this will void the warranty.
- All products are supposed to be used before the end of the period of 12 months based on the product date-code.
- Violation of the technical product specifications such as exceeding the absolute maximum ratings will void the warranty.
- It is also recommended to return the body to the original moisture proof bag and reseal the moisture proof bag again.
- ESD prevention methods need to be followed for manual handling and processing by machinery.

Disclaimer:

This electronic component has been designed and developed for usage in general electronic equipment only. This product is not authorized for use in equipment where a higher safety standard and reliability standard is especially required or where a failure of the product is reasonably expected to cause severe personal injury or death, unless the parties have executed an agreement specifically governing such use. Moreover Würth Elektronik eiSos GmbH & Co. KG products are neither designed nor intended for use in areas such as military, aerospace, aviation, nuclear control, submarine, transportation (automotive control, train control, ship control), transportation signal, disaster prevention, medical, public information network etc. Würth Elektronik eiSos GmbH & Co. KG must be informed about the intent of such usage before the design-in stage. In addition, sufficient reliability evaluation checks for safety must be performed on every electronic component which is used in electrical circuits that require high safety and reliability functions or performance. These cautions and warnings comply with the state of the scientific and technical knowledge and are believed to be accurate and reliable. However, no responsibility is assumed for inaccuracies or incompleteness.

27 IMPORTANT NOTES

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It has to be clearly pointed out that the possibility of a malfunction of electronic components or failure before the end of the usual lifetime cannot be completely eliminated in the current state of the art, even if the products are operated within the range of the specifications. In certain customer applications requiring a very high level of safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health it must be ensured by most advanced technological aid of suitable design of the customer application that no injury or damage is caused to third parties in the event of malfunction or failure of an electronic component.

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Due to constant product improvement product specifications may change from time to time. As a standard reporting procedure of the Product Change Notification (PCN) according to the JEDEC-Standard we inform about minor and major changes. In case of further queries regarding the PCN, the field sales engineer or the internal sales person in charge should be contacted. The basic responsibility of the customer as per Section 1 and 2 remains unaffected.

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Due to technical progress and economical evaluation we also reserve the right to discontinue production and delivery of products. As a standard reporting procedure of the Product Termination Notification (PTN) according to the JEDEC Standard we will inform at an early stage about inevitable product discontinuance. According to this we cannot guarantee that all products within our product range will always be available. Therefore it needs to be verified with the field sales engineer or the internal sales person in charge about the current product availability expectancy before or when the product for application design-in disposal is considered. The approach named above does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.

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